

Evaluation Board User's Manual for High Frequency LQFP32



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Eval Board User's Manual

INTRODUCTION

ON Semiconductor has developed an evaluation board for the devices in 32-lead LQFP package. These evaluation boards are offered as a convenience for the customers interested in performing their own engineering assessment on the general performance of the 32-lead LQFP device samples. The board provides a high bandwidth 50 Ω controlled impedance environment. Figures 1 and 2 show the top and bottom view of the evaluation board, which can be configured in several different ways, depending on device under test (see Table 1. Configuration List).

This evaluation board manual contains:

- Information on 32-lead LQFP Evaluation Board
- Assembly Instructions
- Appropriate Lab Setup
- Bill of Materials

This manual should be used in conjunction with the device data sheet, which contains full technical details on the device specifications and operation.

Board Lay-Up

The 32-lead LQFP evaluation board is implemented in four layers with split (dual) power supplies (see Figure 3. Evaluation Board Lay-Up). For standard ECL lab setup and test, a split (dual) power supply is essential to enable the 50 Ω internal impedance in the oscilloscope as a termination for ECL devices. The first layer or primary trace layer is 0.008" thick Rogers RO4003 material, which is designed to have equal electrical length on all signal traces from the device under the test (DUT) to the sense output. The second layer is the 1.0 oz copper ground. The FR4 dielectric material is placed between second and third layer and between third and fourth layer. The third layer is the power plane (V_{CC} and V_{EE}) and a portion of this layer is a ground plane. The fourth layer is the secondary trace layer.

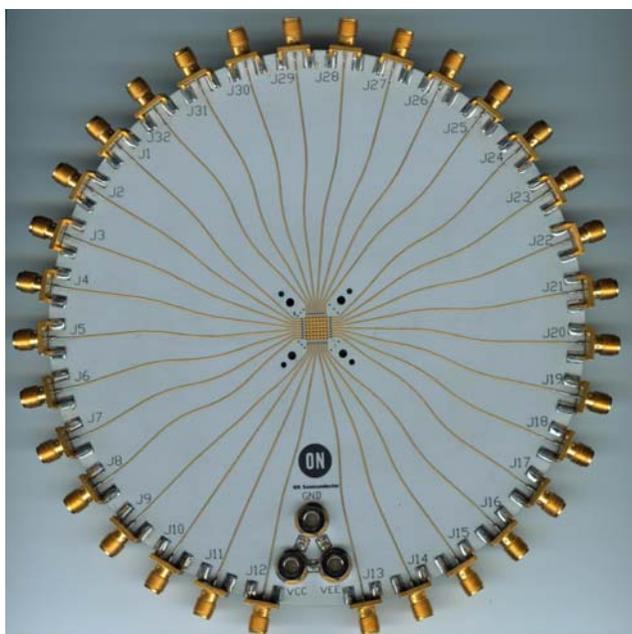
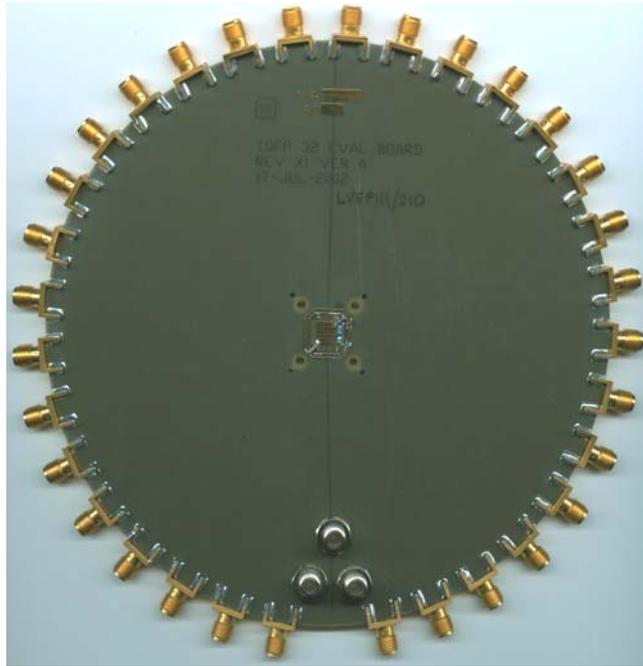
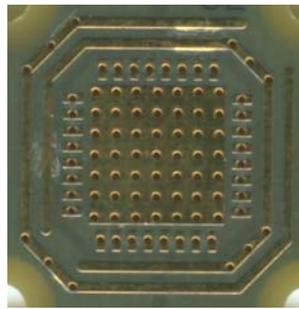


Figure 1. Top View of the 32-lead LQFP Evaluation Board

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Bottom View



Enlarged Bottom View

Figure 2. Bottom View of the 32-lead LQFP Evaluation Board

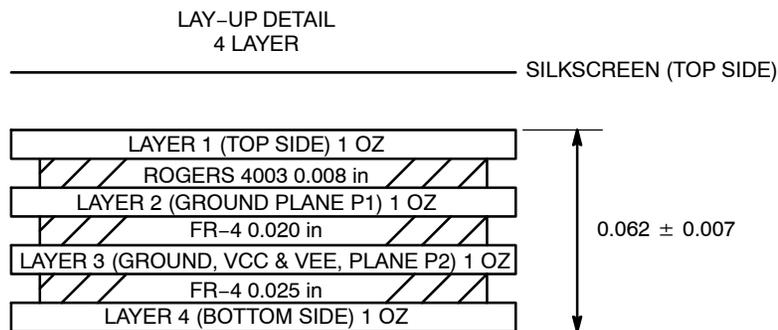


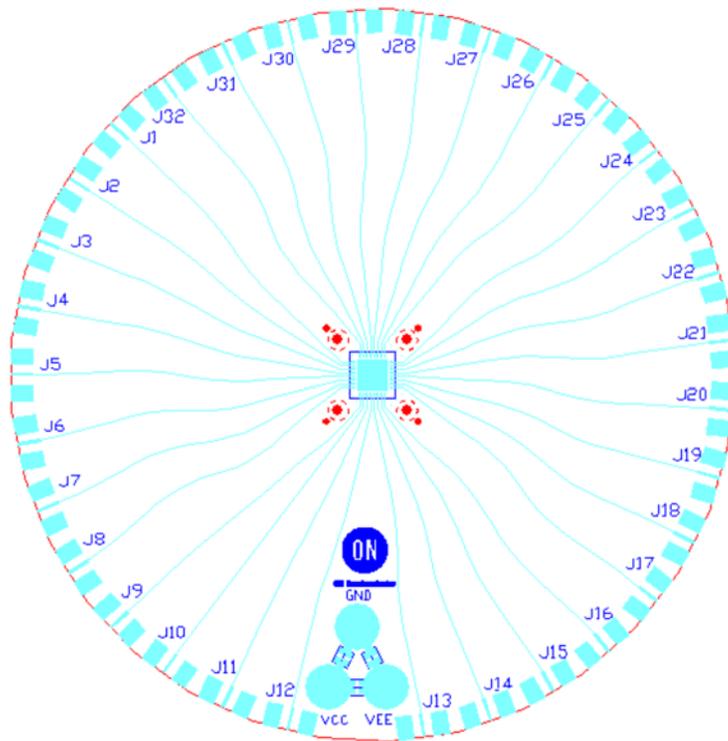
Figure 3. Evaluation Board Lay-up

Board Layout

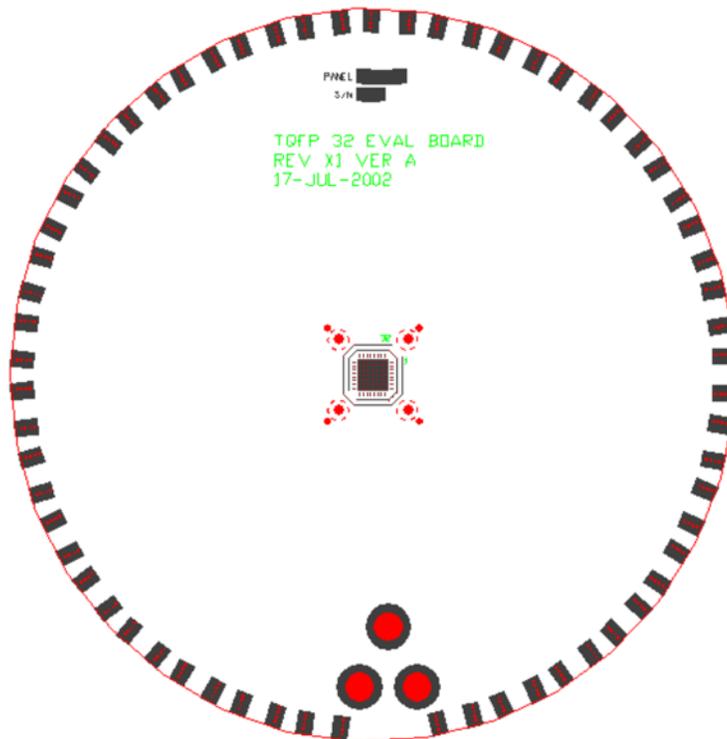
The 32-lead LQFP evaluation board was designed to be versatile and accommodate several different configurations. The input, output, and power pin layout of the evaluation board is shown in Figures 4 and 5. The evaluation board has at least thirteen possible configurable options. Table 1, list the devices and the relevant configuration that utilizes this

PCB board. Lists of components and simple schematics are located in Figures 6 through 18. Place SMA connectors on J1 through J32, 50 Ω chip resistors between ground pad and Pin 1 pad through Pin 32 pad, and chip capacitors C1 through C5 according to configuration figures. (C4 and C5 are 0.01 μF and C1, C2, and C3 are 0.1 μF); (See Figure 5).

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Top View



Bottom View

Figure 4. Evaluation Board Layout

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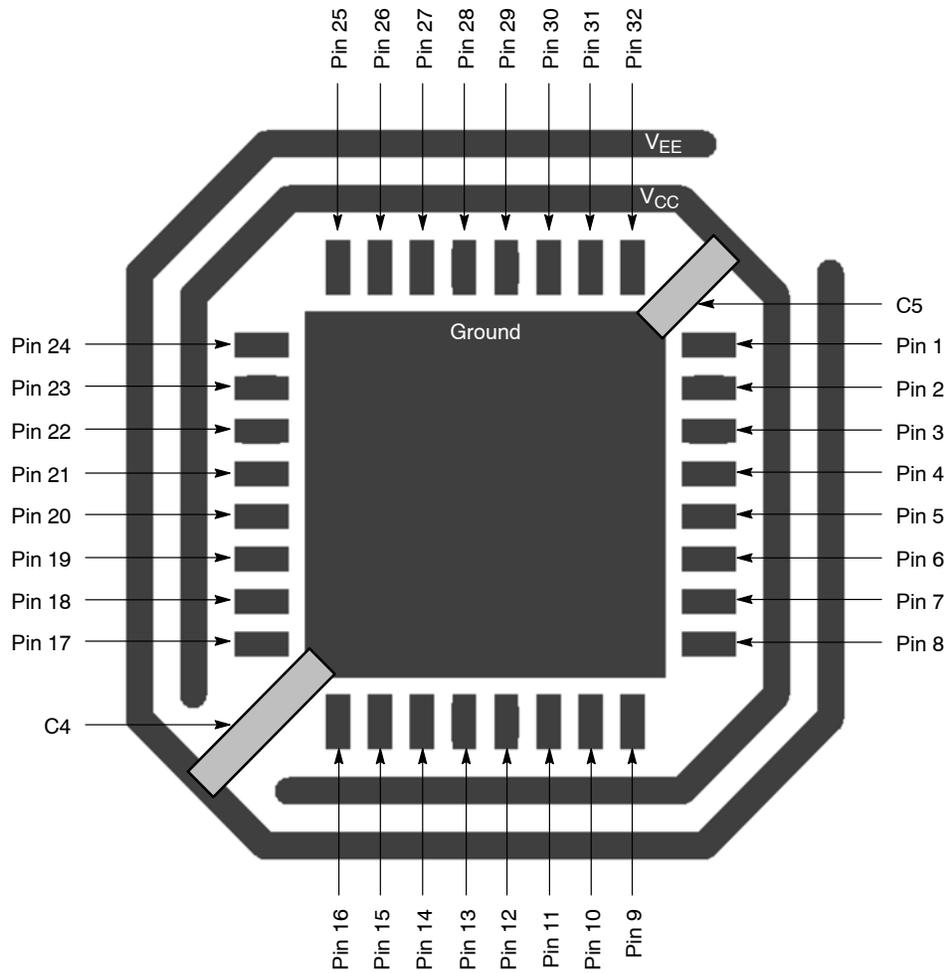


Figure 5. Enlarged Bottom View of the Evaluation Board

Table 1. Configuration List

Configuration	Comments	Device
1	See Figure 6	LVE164
2	See Figure 7	EP016 / EP016A
3	See Figure 8	EP101 / EP105
4	See Figure 9	EP116
5	See Figure 10	EP131
6	See Figure 11	EP142
7	See Figure 12	EP195 / EP196
8	See Figure 13	EP445
9	See Figure 14	EP446
10	See Figure 15	EP451
11	See Figure 16	EP809
12	See Figure 17	LVEP111 / LVEP210
13	See Figure 18	LVEP210S

Evaluation Board Assembly Instructions

The 32-lead LQFP evaluation board is designed for characterizing devices in a 50 Ω laboratory environment using high bandwidth equipment. Each signal trace on the board has a via, which has an option of placing a termination resistor depending on the input/output configuration (see Table 1, Configuration List). Table 17 contains the Bill of Materials for this evaluation board.

Solder the Device on the Evaluation Board

The soldering can be accomplished by hand soldering or soldering re-flow techniques. Make sure pin 1 of the device is located next to the white dotted mark and all the pins are aligned to the footprint pads. Solder the 32-lead LQFP device to the evaluation board.

Connecting Power and Ground Planes

For standard ECL lab setup and test, a split (dual) power supply is required enabling the 50 Ω internal impedance in the oscilloscope to be used as a termination of the ECL signals ($V_{TT} = V_{CC} - 2.0\text{ V}$, in split power supply setup, V_{TT} is the system ground, V_{CC} is 2.0 V, and V_{EE} is -3.0 V or -1.3 V; see Table 2, Power Supply Levels).

Table 2. Power Supply Levels

Power Supply	V_{CC}	V_{EE}	GND
5.0 V	2.0 V	-3.0 V	0.0 V
3.3 V	2.0 V	-1.3 V	0.0 V
2.5 V	2.0 V	-0.5 V	0.0 V

Connect three banana jack sockets to V_{CC} , V_{EE} , and GND labeled holes. Wire bond the appropriate device pin pad on the bottom side of the board to V_{CC} and V_{EE} power stripes. (Device specific, please see configuration for each desired device. See Figure 5)

It is recommended to solder 0.01 μF capacitors to C4 and C5 to reduce the unwanted noise from the power supplies. C1, C2, and C3 pads are provided for 0.1 μF capacitor to further diminish the noise from the power supplies. Adding capacitors can improve edge rates, reduce overshoot and undershoot.

Termination

All ECL outputs need to be terminated to V_{TT} ($V_{TT} = V_{CC} - 2.0\text{ V} = \text{GND}$) via a 50 Ω resistor. 0402 chip resistor pads are provided on the bottom side of the evaluation board to terminate the ECL driver (More information on termination is provided in AN8020). Solder the chip resistors to the bottom side of the board between the appropriate input of the device pin pads and the ground pads. For ease of assembly, it is advised to place and solder termination resistors on its vertical (side) position, instead of its original or flat position.

Installing the SMA Connectors

Each configuration indicates the number of SMA connectors needed to populate an evaluation board for a given configuration. Each input and output requires one SMA connector. Attach all the required SMA connectors onto the board and solder the connectors to the board on J1 through J32. Please note that alignment of the signal connector pin of the SMA can influence the lab results. The reflection and launch of the signals are largely influenced by imperfect alignment and soldering of the SMA connector.

Validating the Assembled Board

After assembling the evaluation board, it is recommended to perform continuity checks on all soldered areas before commencing with the evaluation process. Time Domain Reflectometry (TDR) is another highly recommended validation test.

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CONFIGURATIONS

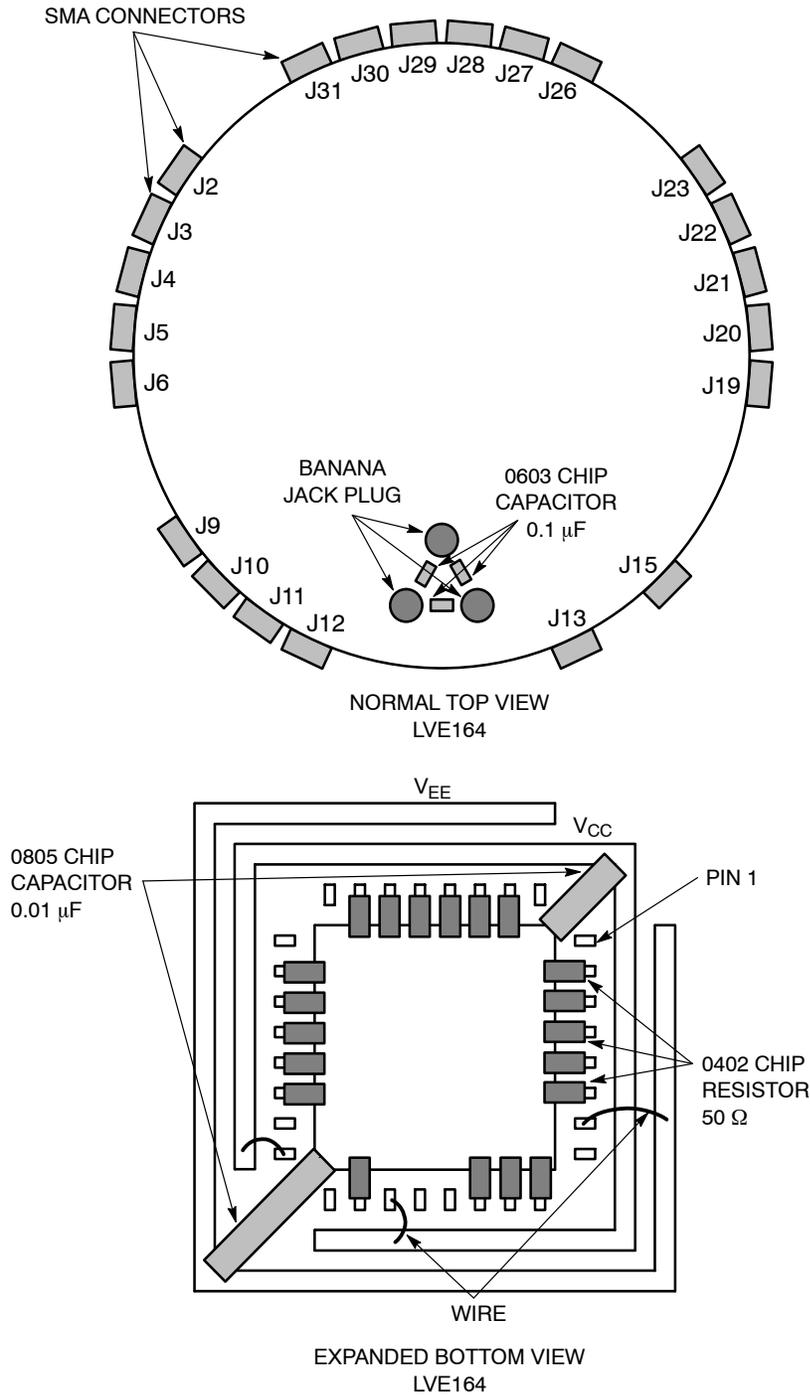


Figure 6. Configuration 1

Table 3. Configuration 1 (Device LVE164)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32
Connector	N	Y	Y	Y	Y	Y	N	N	Y	Y	Y	Y	Y	N	Y	N	N	N	Y	Y	Y	Y	Y	N	N	N	Y	Y	Y	Y	Y	N
Resistor	N	Y	Y	Y	Y	Y	N	N	Y	Y	Y	N	N	N	Y	N	N	N	Y	Y	Y	Y	Y	N	N	N	Y	Y	Y	Y	Y	N
Power	N	N	N	N	N	N	Y	N	N	N	N	N	N	Y	N	N	N	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N

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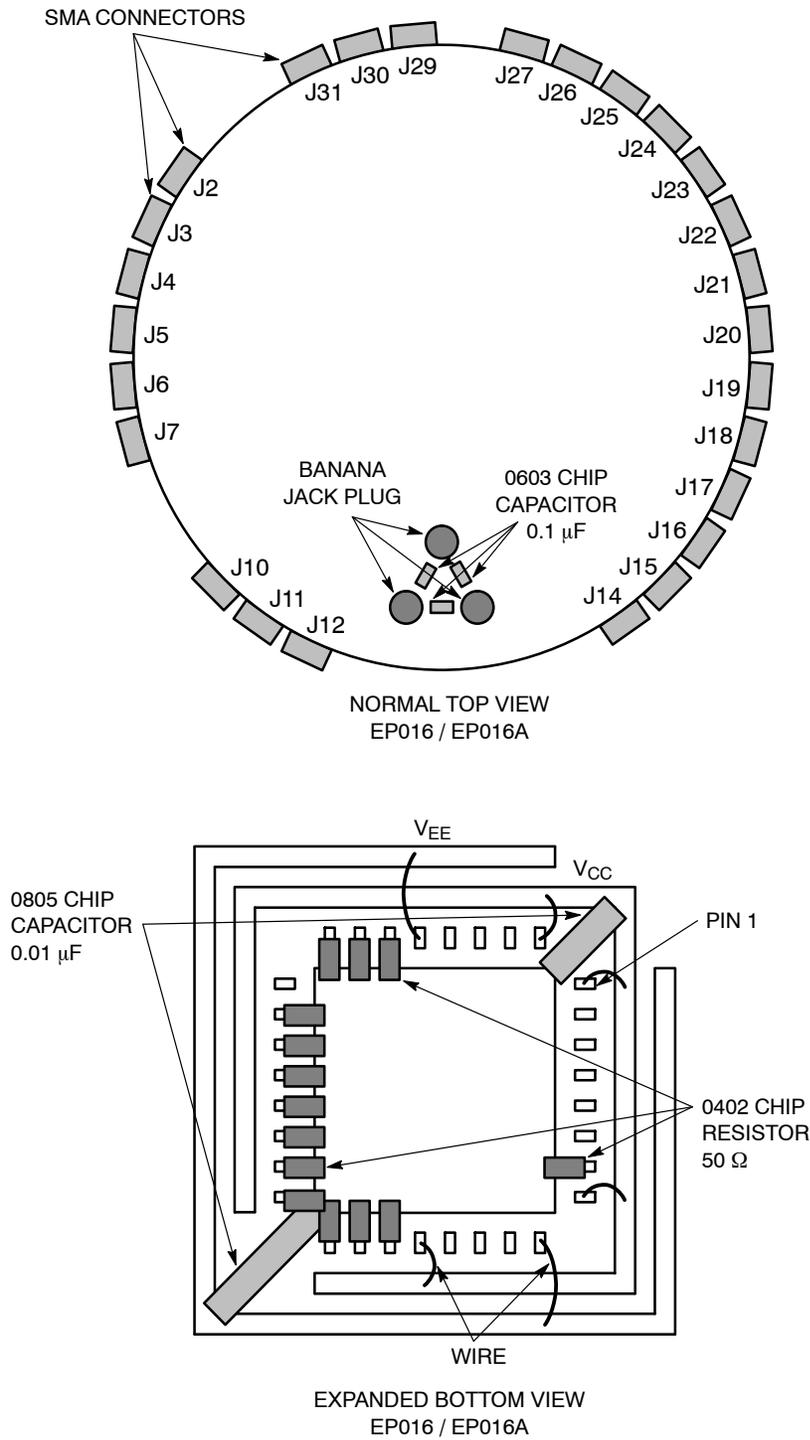


Figure 7. Configuration 2

Table 4. Configuration 2 (Device EP016 and EP016A)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32
Connector	N	Y	Y	Y	Y	Y	Y	N	N	Y	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	N
Resistor	N	N	N	N	N	N	Y	N	N	N	N	N	N	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	N	N	N	N	N
Power	Y	N	N	N	N	N	N	Y	Y	N	N	N	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	Y	N	N	N	Y

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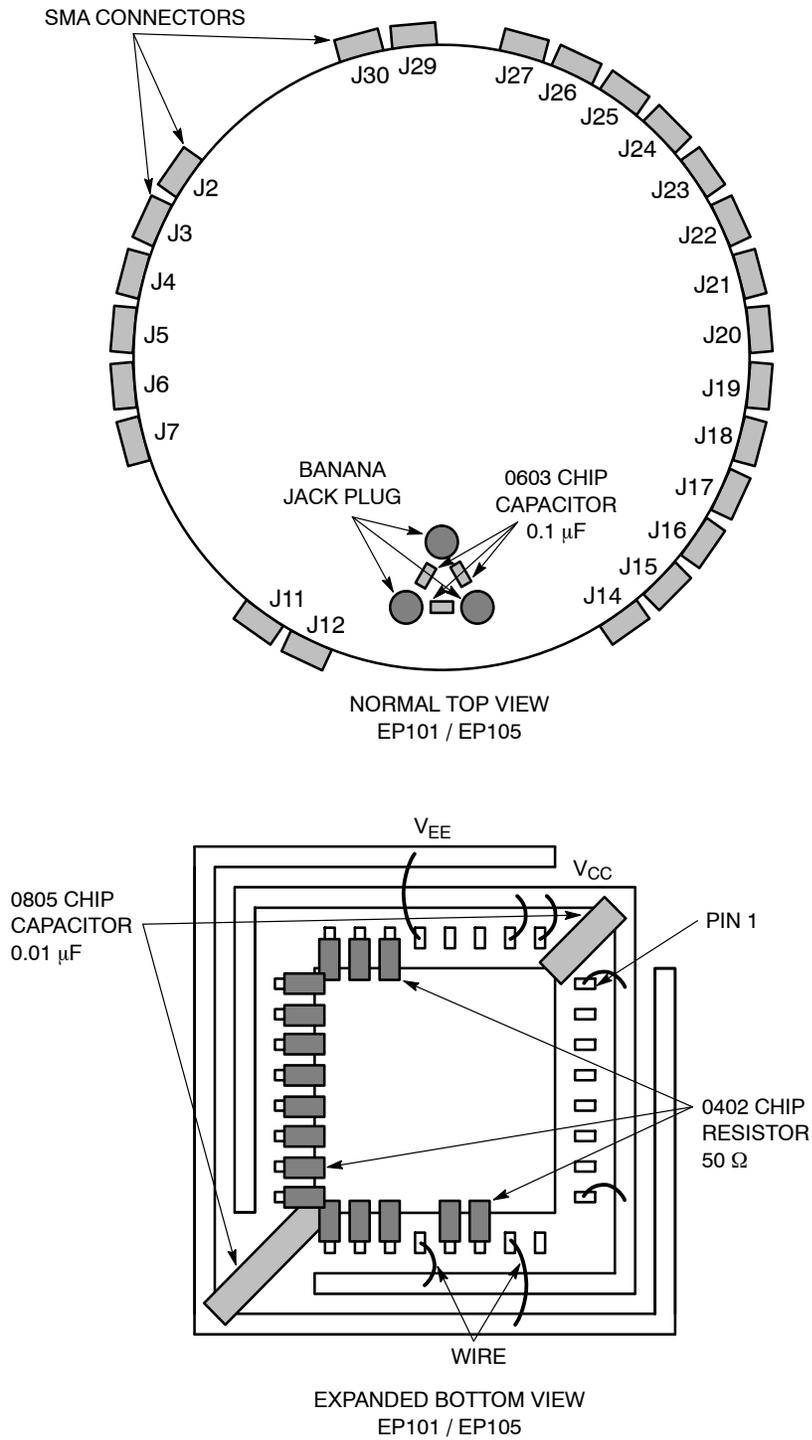


Figure 8. Configuration 3

Table 5. Configuration 3 (Device EP101 and EP105)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	N	Y	Y	Y	Y	Y	Y	N	N	N	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	N	N	
Resistor	N	N	N	N	N	N	N	N	N	N	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	N	N	N	N	
Power	Y	N	N	N	N	N	N	Y	N	Y	N	N	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	Y	N	N	Y	Y

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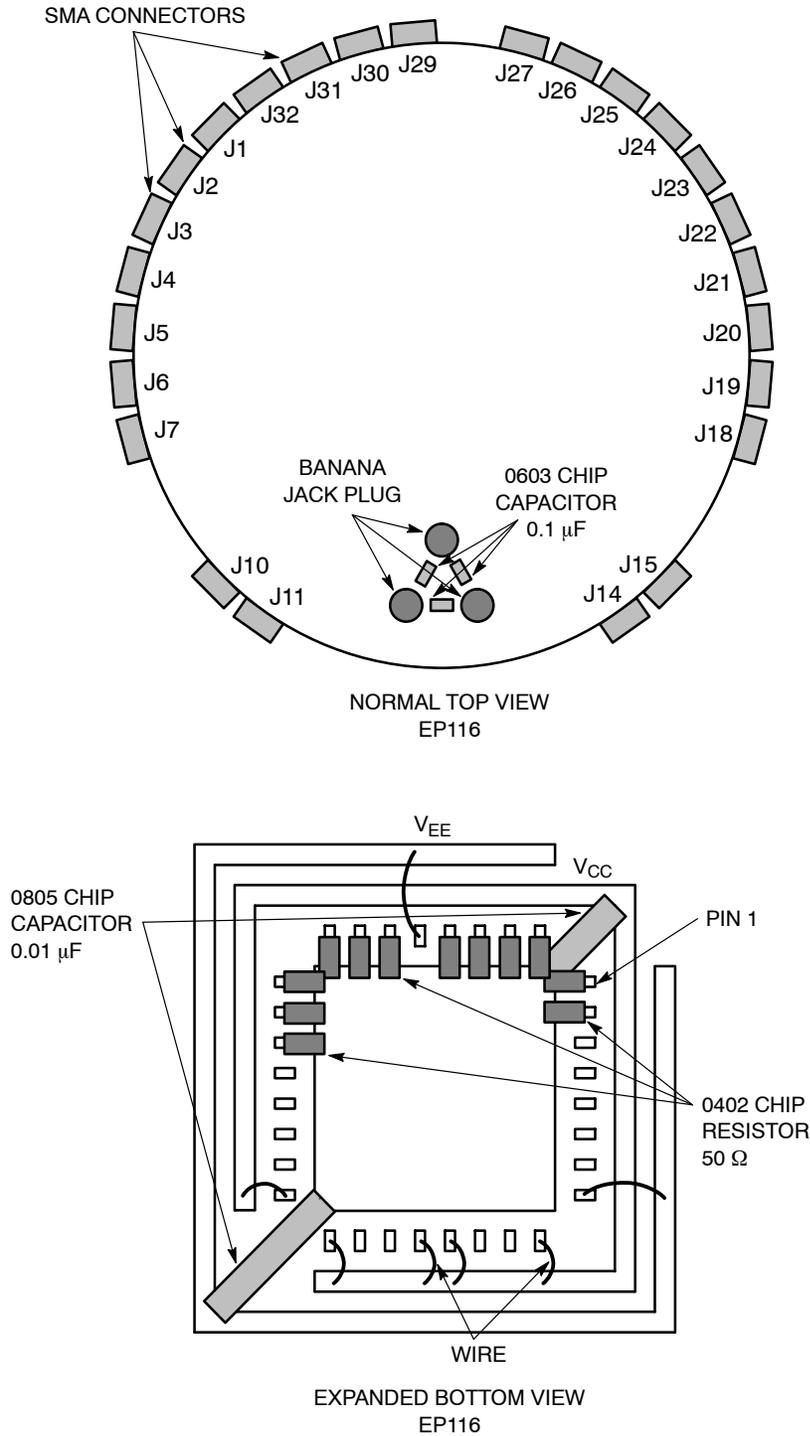


Figure 9. Configuration 4

Table 6. Configuration 4 (Device EP116)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	Y	Y	Y	Y	Y	Y	Y	N	N	Y	Y	N	N	Y	Y	N	N	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	
Resistor	Y	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y
Power	N	N	N	N	N	N	N	Y	Y	N	N	Y	Y	N	N	Y	Y	N	N	N	N	N	N	N	N	N	N	Y	N	N	N	N	

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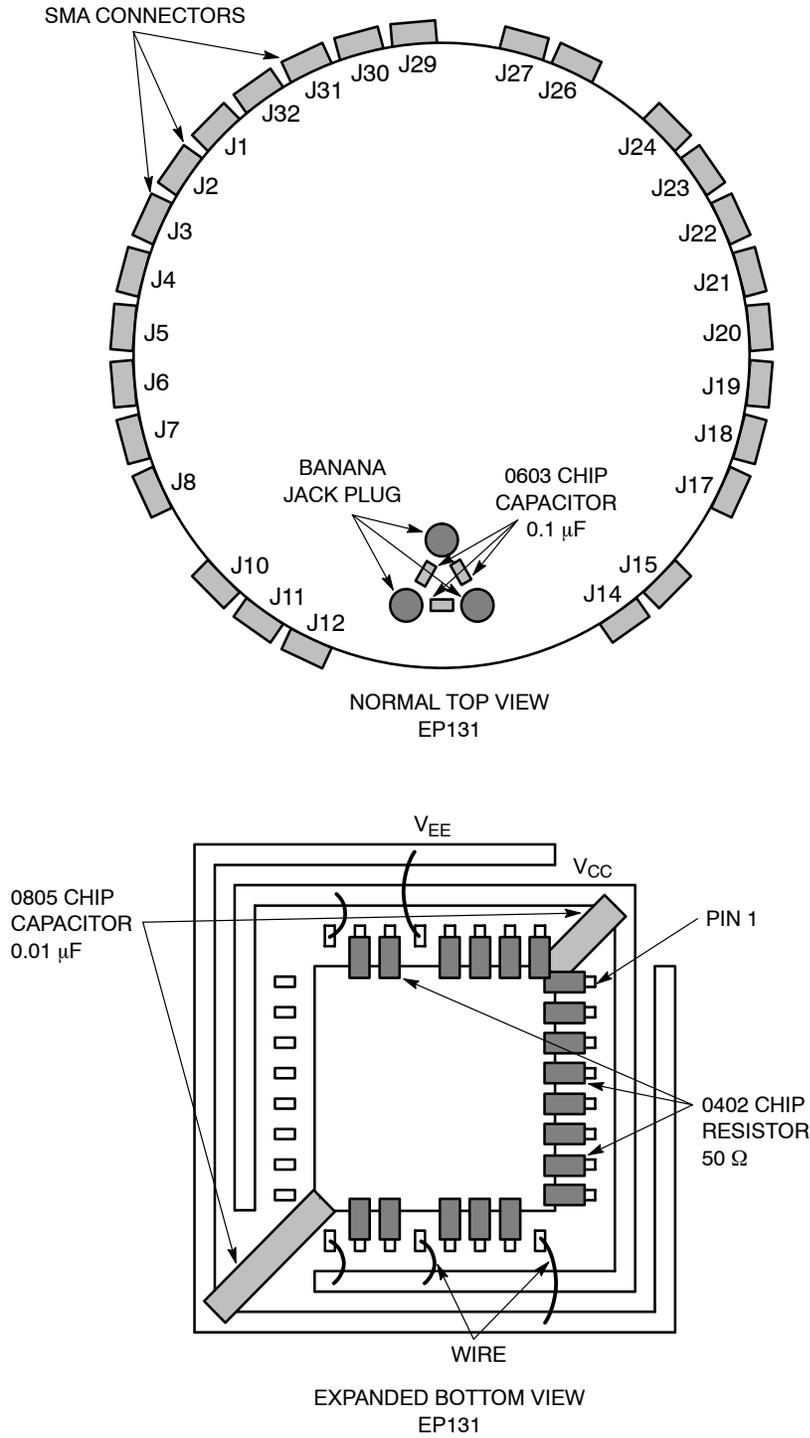


Figure 10. Configuration 5

Table 7. Configuration 5 (Device EP131)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	N	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	N	Y	Y	Y	Y	
Resistor	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	N	Y	Y	N	N	N	N	N	N	N	N	N	N	N	Y	Y	N	Y	Y	Y	Y
Power	N	N	N	N	N	N	N	N	Y	N	N	N	Y	N	N	Y	N	N	N	N	N	N	N	N	N	Y	N	N	Y	N	N	N	N

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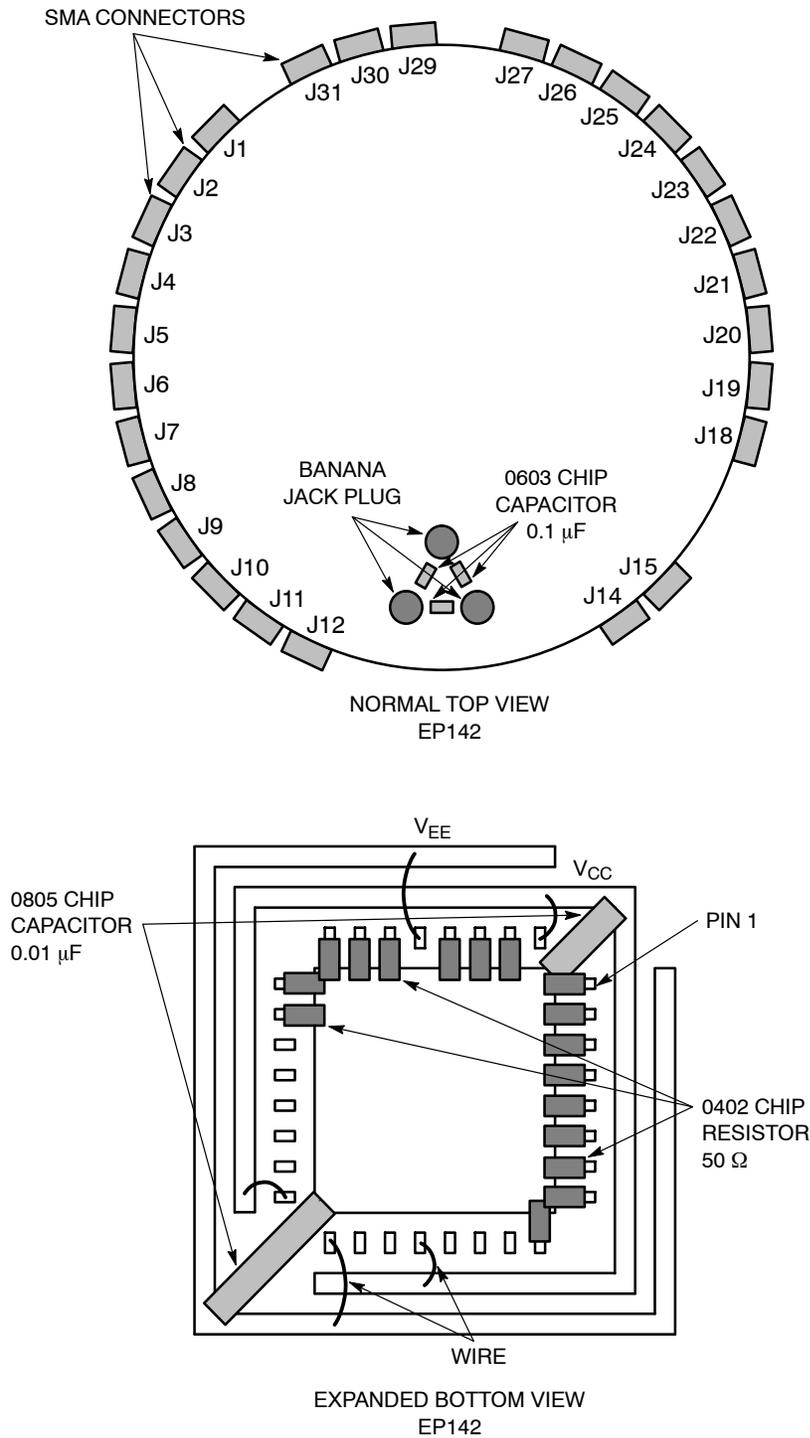


Figure 11. Configuration 6

Table 8. Configuration 6 (Device EP142)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32
Connector	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	N	N	N	N	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	N
Resistor	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	Y	Y	Y	Y	Y	N	Y	Y	Y	N
Power	N	N	N	N	N	N	N	N	N	N	N	N	Y	Y	Y	Y	Y	N	N	N	N	N	N	N	N	N	N	Y	N	N	N	Y

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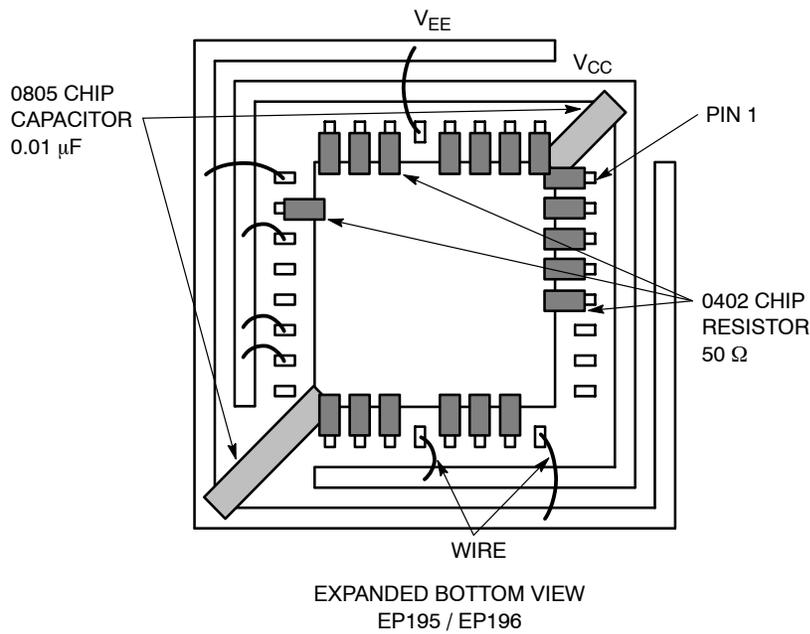
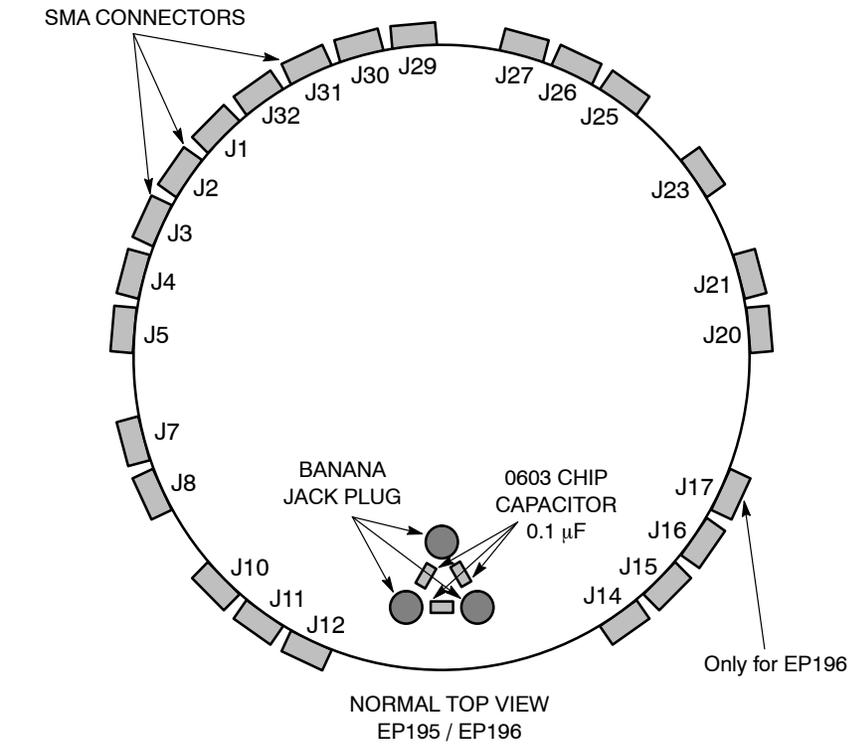


Figure 12. Configuration 7

Table 9. Configuration 7 (Device EP195 and EP196)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	N	Y	Y	*	N	N	Y	Y	N	Y	N	Y	Y	Y	N	Y	Y	Y	Y	
Resistor	Y	Y	Y	Y	Y	N	N	N	N	Y	Y	Y	Y	N	Y	Y	N	N	N	N	N	N	Y	N	Y	Y	Y	Y	N	Y	Y	Y	Y
Power	N	N	N	N	N	N	N	N	Y	N	N	N	N	Y	N	N	N	Y	Y	N	N	Y	N	Y	N	N	N	Y	N	N	N	N	N

* Only for EP196

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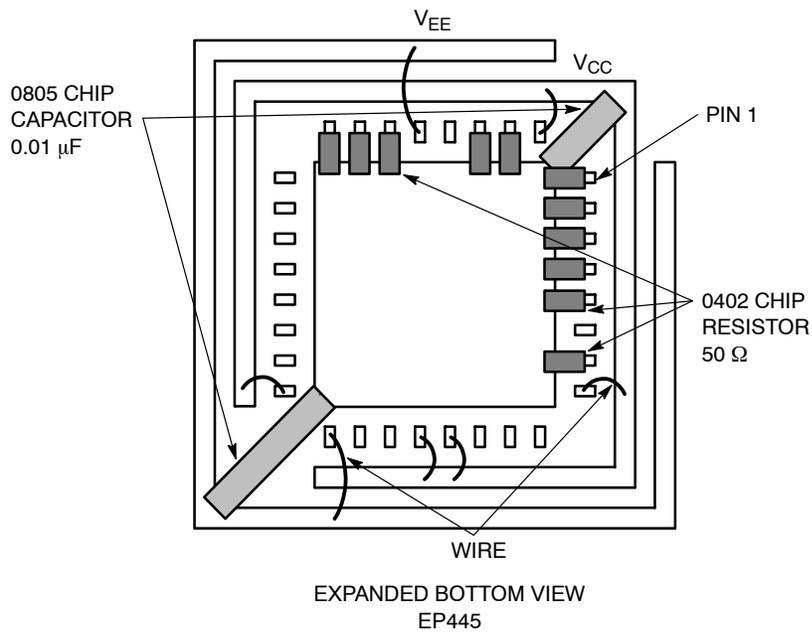
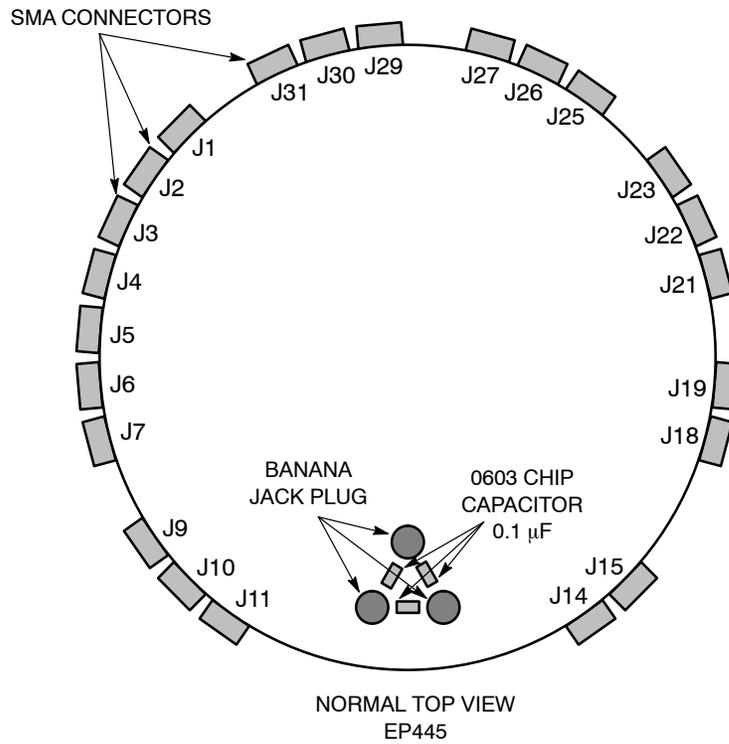


Figure 13. Configuration 8

Table 10. Configuration 8 (Device EP445)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32
Connector	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	N	Y	Y	N	N	Y	Y	N	Y	Y	Y	N	Y	Y	Y	N	Y	Y	Y	N
Resistor	Y	Y	Y	Y	Y	N	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	Y	Y	N	Y	Y	Y	N	N	Y	Y	N
Power	N	N	N	N	N	N	N	N	N	N	N	Y	Y	N	N	Y	Y	N	N	Y	N	N	N	Y	N	N	N	Y	N	N	N	Y

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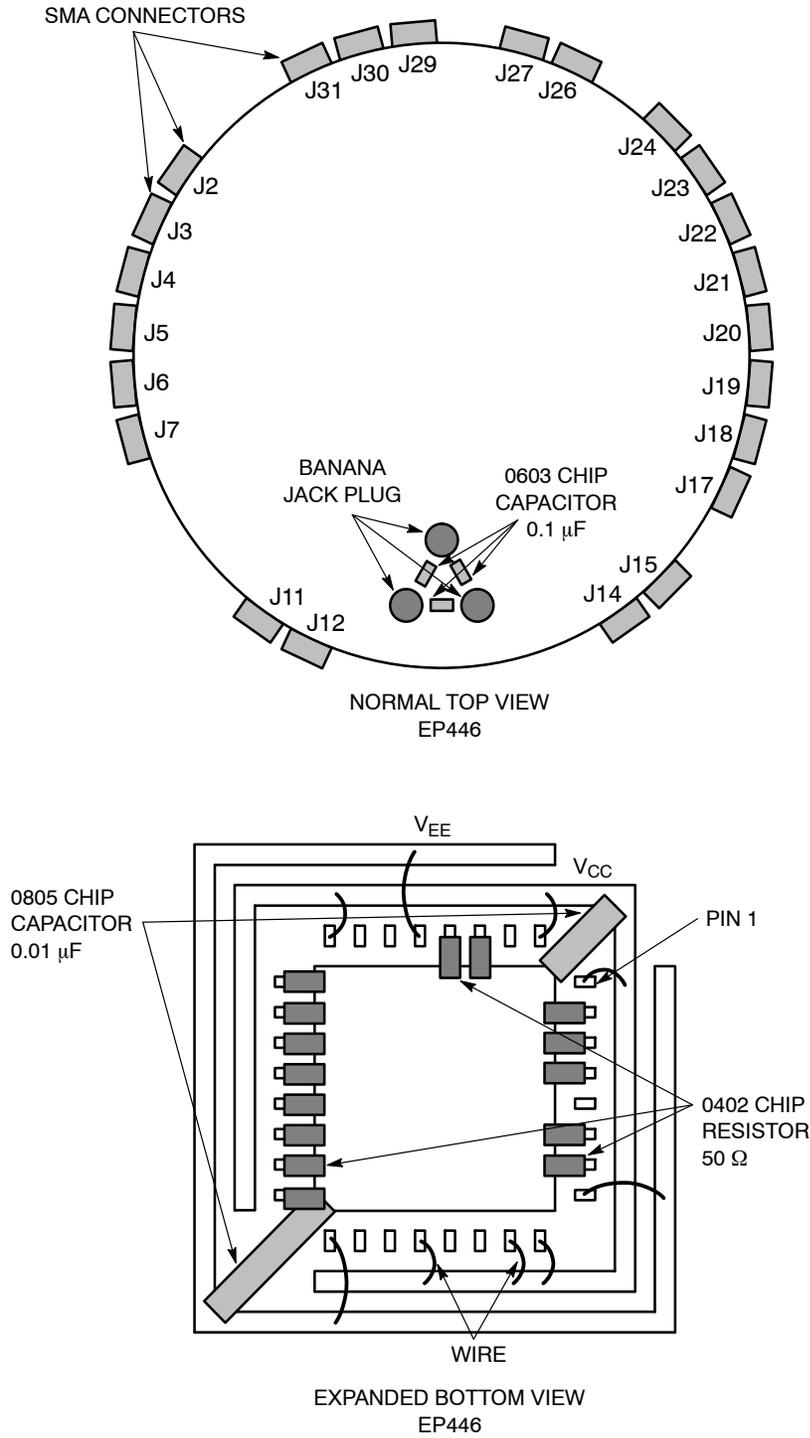


Figure 14. Configuration 9

Table 11. Configuration 9 (Device EP446)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	N	Y	Y	Y	Y	Y	Y	N	N	N	Y	Y	N	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	N	Y	Y	Y	N	
Resistor	N	Y	Y	Y	N	Y	Y	N	N	N	N	N	N	N	N	N	Y	Y	Y	Y	Y	Y	Y	Y	Y	N	N	N	N	Y	Y	N	N
Power	Y	N	N	N	N	N	N	Y	Y	Y	N	N	Y	N	N	Y	N	N	N	N	N	N	N	N	N	Y	N	N	Y	N	N	N	Y

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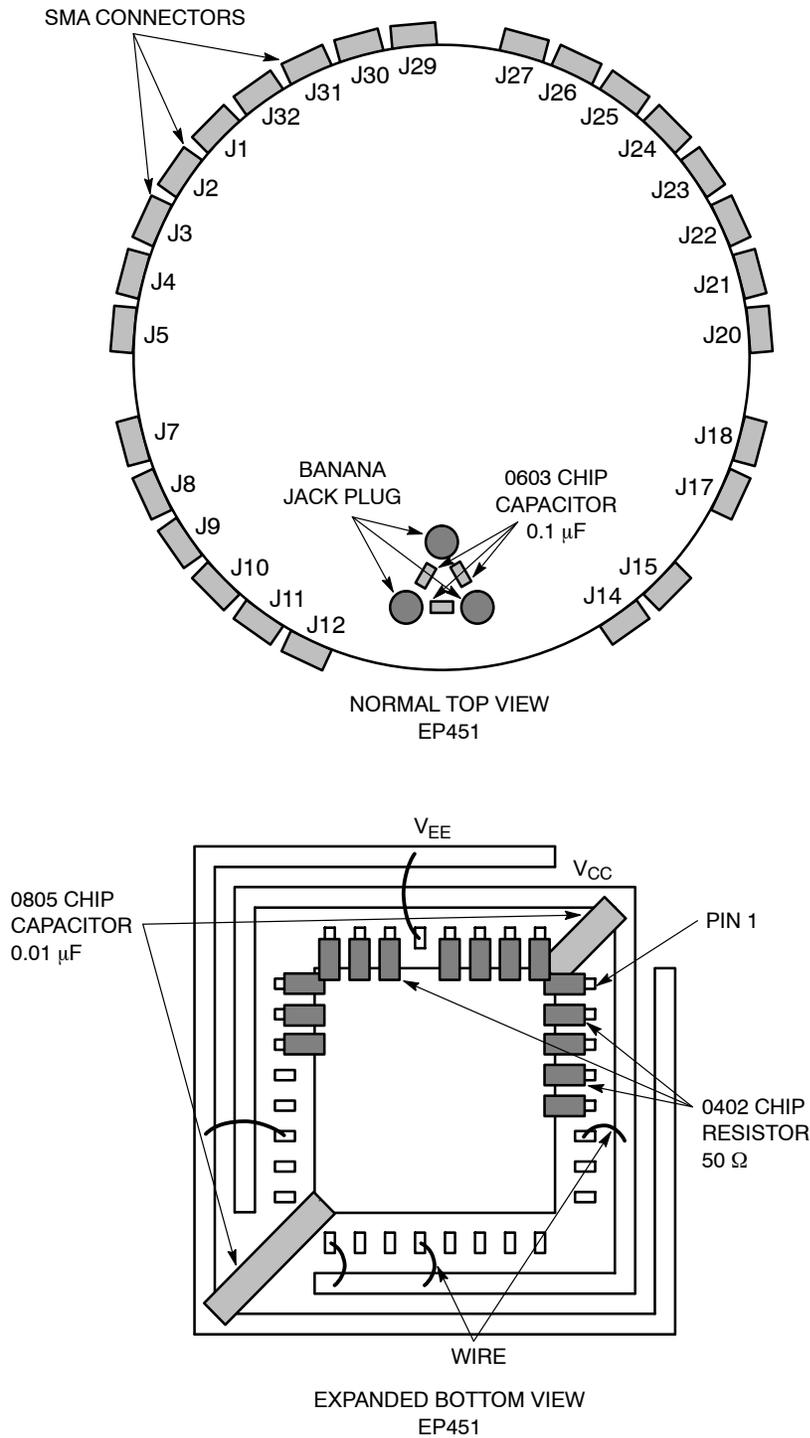


Figure 15. Configuration 10

Table 12. Configuration 10 (Device EP451)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	Y	Y	N	Y	Y	N	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	
Resistor	Y	Y	Y	Y	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y
Power	N	N	N	N	N	Y	N	N	N	N	N	N	Y	N	N	Y	N	N	Y	N	N	N	N	N	N	N	N	N	Y	N	N	N	N

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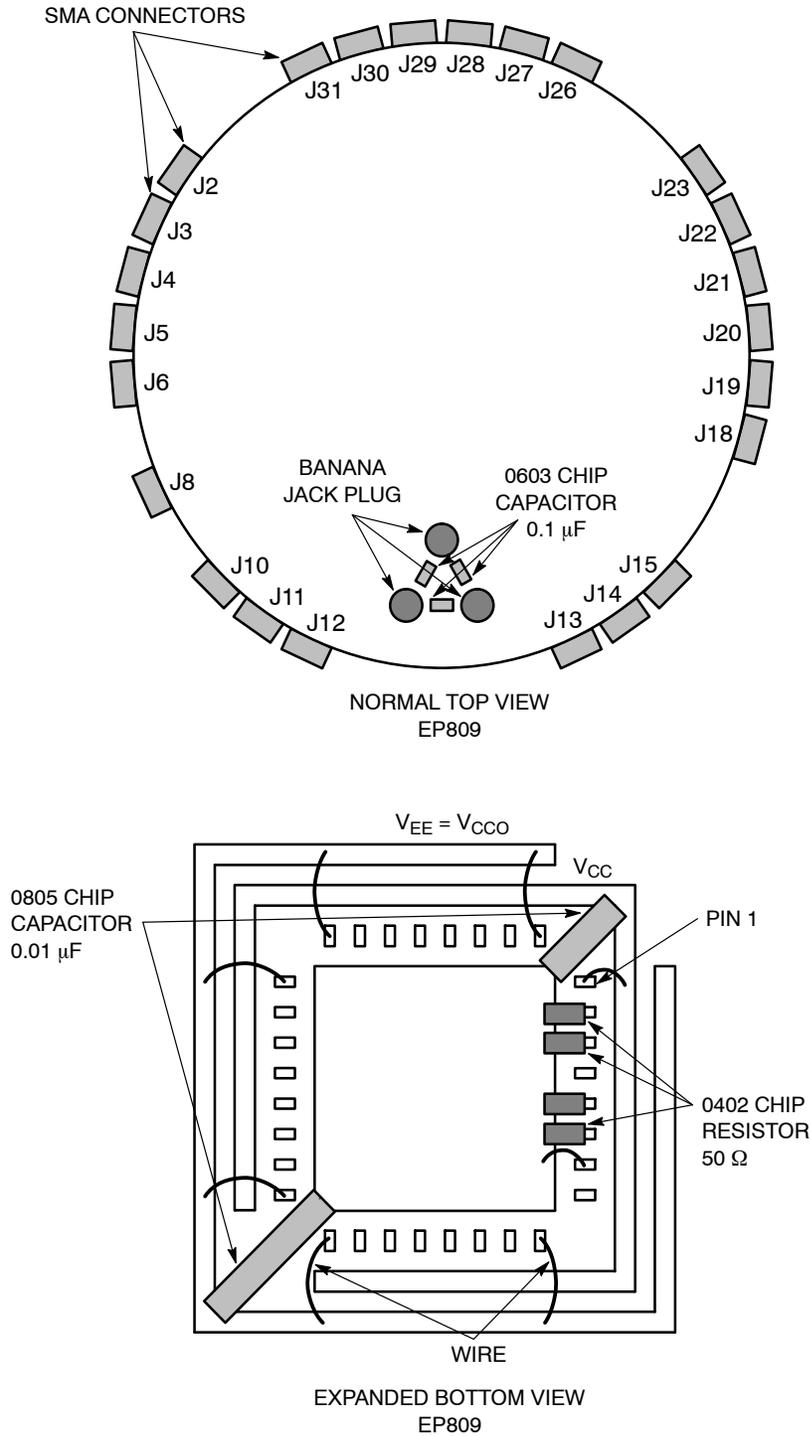


Figure 16. Configuration 11

Table 13. Configuration 11 (Device EP809)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	N	Y	Y	Y	Y	Y	N	Y	N	Y	Y	Y	Y	Y	Y	N	N	Y	Y	Y	Y	Y	Y	N	N	Y	Y	Y	Y	Y	Y	N	
Resistor	N	Y	Y	Y	Y	Y	N	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N
Power	Y	N	N	N	N	N	Y	N	Y	N	N	N	N	N	N	Y	Y	N	N	N	N	N	N	Y	Y	N	N	N	N	N	N	N	Y

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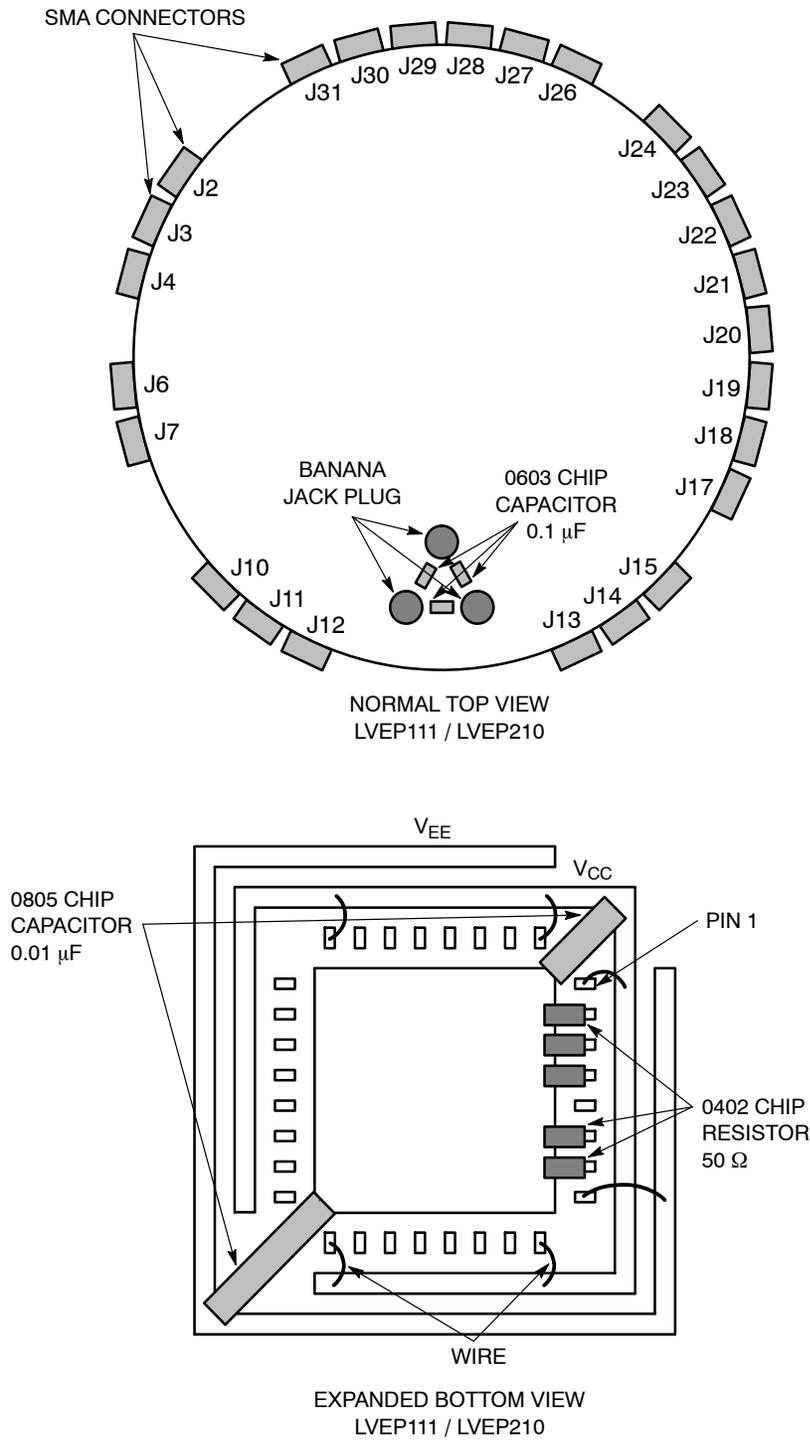


Figure 17. Configuration 12

Table 14. Configuration 12 (Device LVEP111 and LVEP210)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	N	Y	Y	Y	Y	Y	Y	N	N	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	Y	Y	N	
Resistor	N	Y	Y	Y	N	Y	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N
Power	Y	N	N	N	N	N	N	Y	Y	N	N	N	N	N	N	Y	N	N	N	N	N	N	N	N	N	Y	N	N	N	N	N	N	Y

* Pin 2 is No Connect for LVEP210

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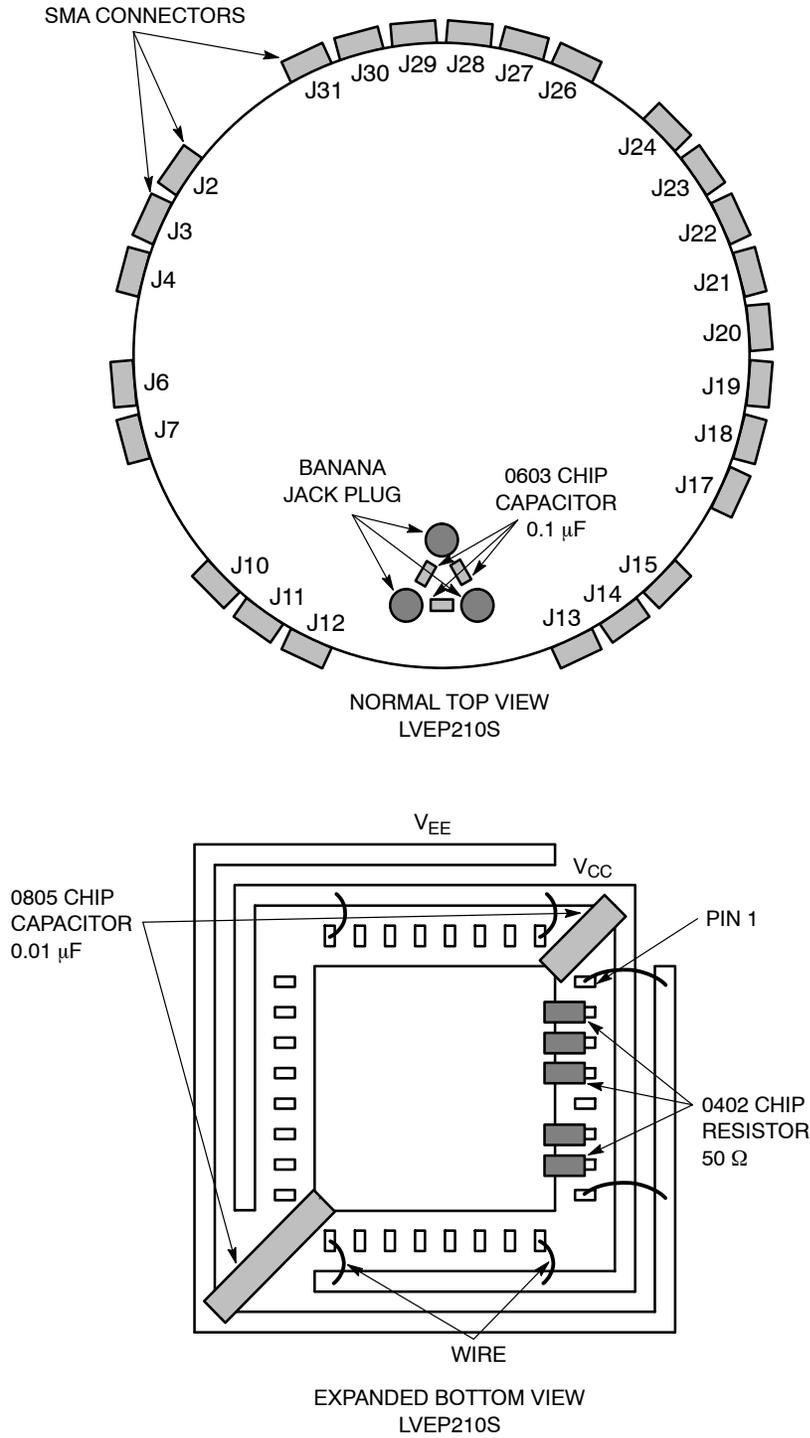


Figure 18. Configuration 13

Table 15. Configuration 13 (Device LVEP210S)

Device	J1	J2	J3	J4	J5	J6	J7	J8	J9	J10	J11	J12	J13	J14	J15	J16	J17	J18	J19	J20	J21	J22	J23	J24	J25	J26	J27	J28	J29	J30	J31	J32	
Pin #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
Connector	N	Y	Y	Y	Y	Y	Y	N	N	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	Y	Y	Y	Y	N	Y	Y	Y	Y	Y	Y	N	
Resistor	N	Y	Y	Y	Y	Y	Y	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N
Power	Y	N	N	N	N	N	N	Y	Y	N	N	N	N	N	N	Y	N	N	N	N	N	N	N	N	N	Y	N	N	N	N	N	N	Y

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LAB SETUP

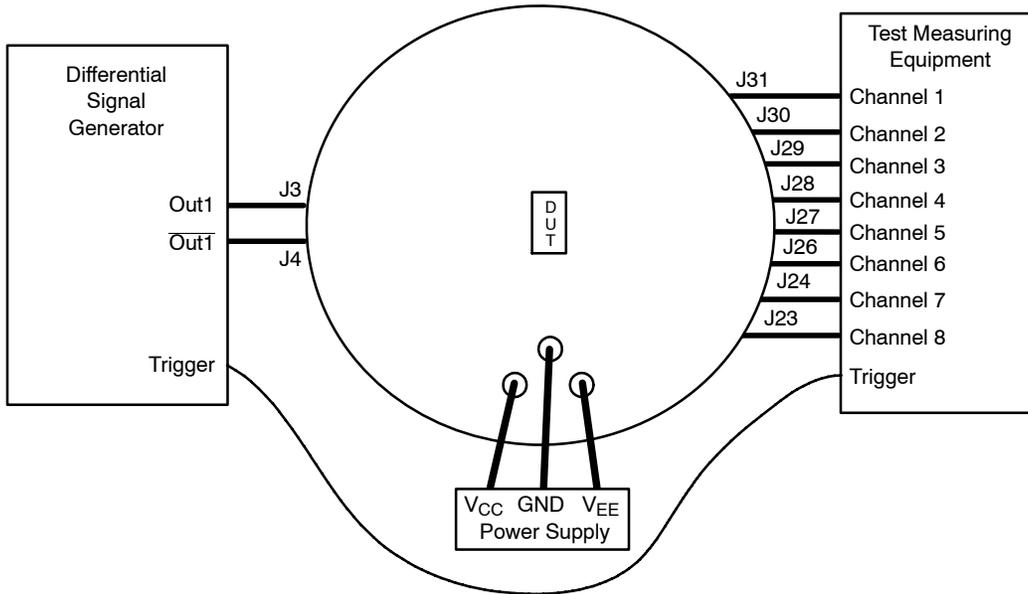


Figure 19. Example of Standard Lab Setup (Configuration 12)

1. Connect appropriate power supplies to V_{CC} , V_{EE} , and GND.

For standard ECL lab setup and test, a split (dual) power supply is required enabling the $50\ \Omega$ internal impedance in the oscilloscope to be used as a termination of the ECL signals ($V_{TT} = V_{CC} - 2.0\ \text{V}$, in split power supply setup, V_{TT} is the system ground, V_{CC} is $2.0\ \text{V}$, and V_{EE} is $-3.0\ \text{V}$ or $-1.3\ \text{V}$; see Table 16).

2. Connect a signal generator to the input SMA connectors. Setup input signal according to the device data sheet.

3. Connect a test measurement device on the device output SMA connectors.

NOTE: The test measurement device must contain $50\ \Omega$ termination.

Table 16. Power Supply Levels

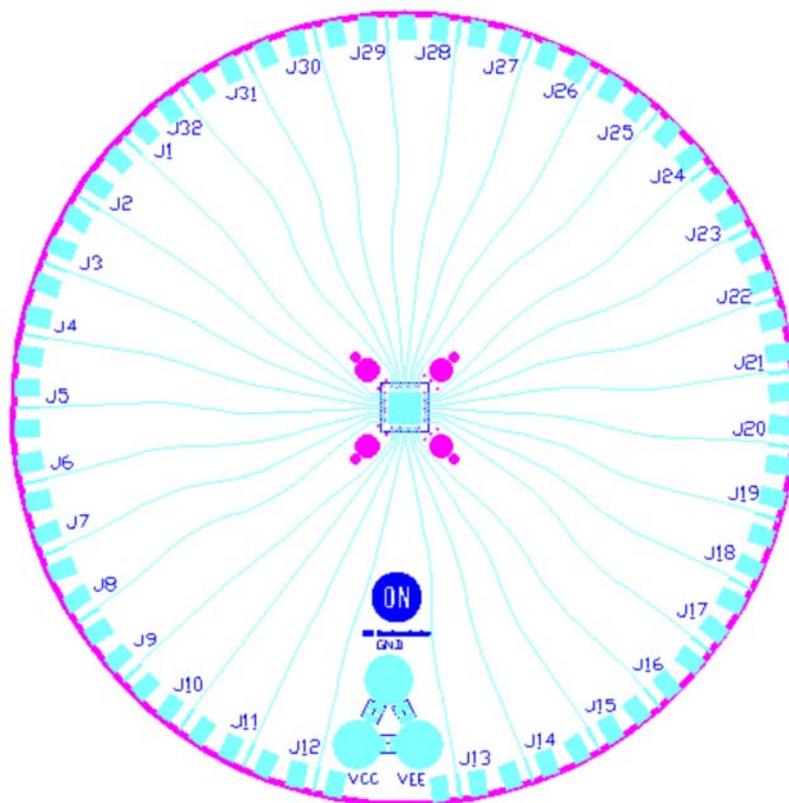
Power Supply	V_{CC}	V_{EE}	GND
5.0 V	2.0 V	-3.0 V	0.0 V
3.3 V	2.0 V	-1.3 V	0.0 V
2.5 V	2.0 V	-0.5 V	0.0 V

Table 17. Bill of Materials

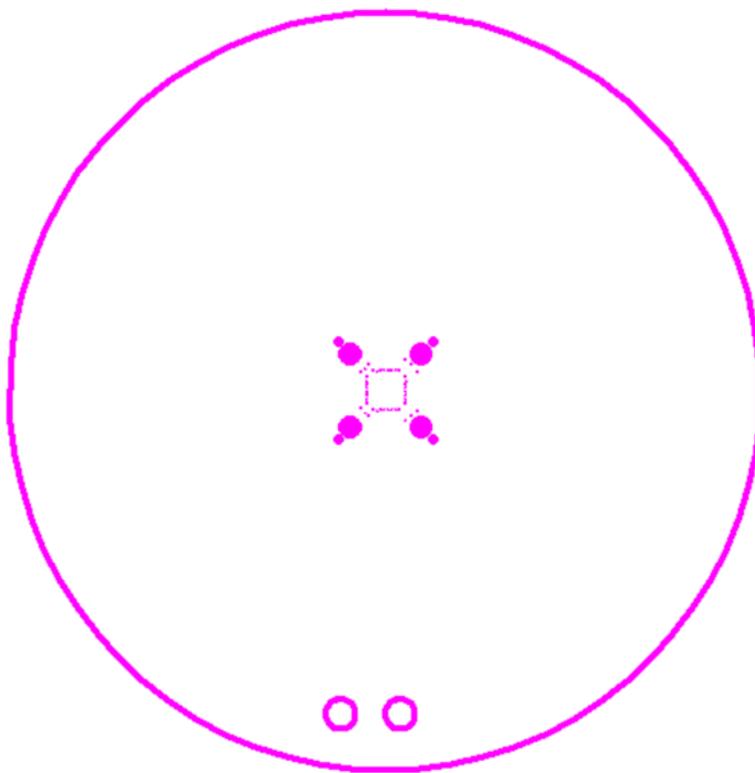
Components	Manufacturer	Description	Part Number	Web Site
SMA Connector	Johnson Components*	SMA Connector, Side Launch, Gold Plated	142-0701-851	http://www.johnsoncomponents.com
Banana Jack	Keystone*	Standard Jack	6096	http://www.keyelco.com
		Miniature Jack	6090	
Chip Capacitor	Johanson Dielectric*	0603/0805/1205 0.01 μF Chip Capacitor	-	http://www.johansondielectrics.com
		0603/0805/1205 0.1 μF Chip Capacitor	-	
Chip Resistor	Panasonic*	0402 50 Ω $\pm 1\%$ Precision Think Film Chip Resistor	ERJ-2RKF49R9X	http://www.panasonic.com
Evaluation Board	ON Semiconductor	LQFP32 Evaluation Board	ECLLQFP32EVB	http://www.onsemi.com
Device Samples	ON Semiconductor	LQFP32 Package Device	Various	http://www.onsemi.com

*Components are available through most distributors, i.e. www.newark.com, www.digikey.com.

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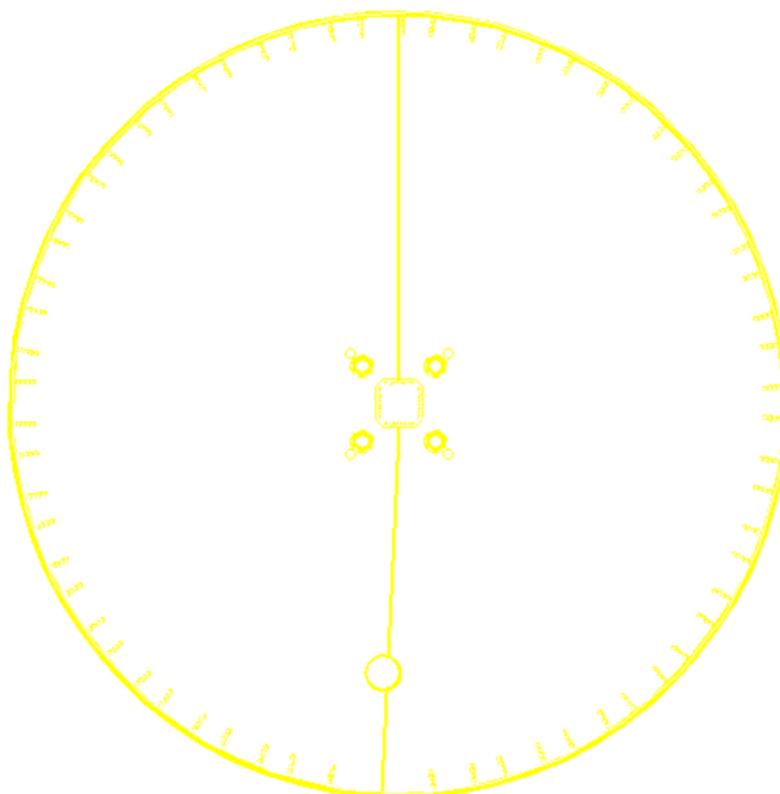
Top View



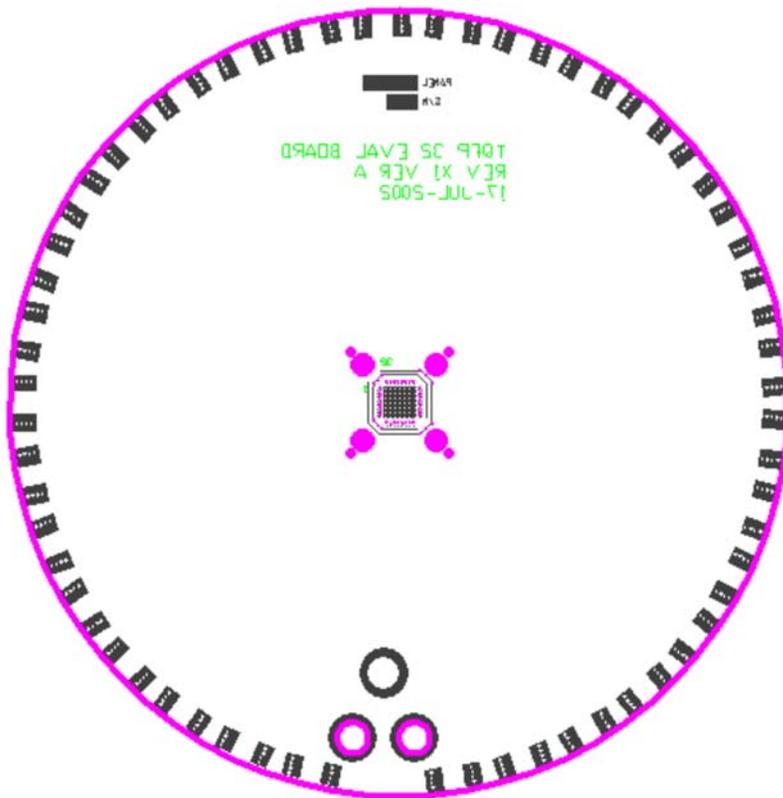
Second Layer (Ground Plane)

Figure 20. Gerber Files

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Third Layer (Power and Ground Plane)
(Left side - V_{CC}, Right side - V_{EE}, Middle Box - Ground)



Bottom Layer

Figure 21. Gerber Files

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